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TRA	NSMITTA	Docket No. BUR920040182US1							
In Re Application Of: Fen Chen et al.									
Application No.		Filing DELOCATION	Examiner	Customer No.	Group Art Unit	Confirmation No.			
10/7	11,418	09/17/2004		30449	2812				
Title: NON-DESTRUCTIVE EVALUATION OF MICROSTRUCTURE AND INTERFACE ROUGHNESS OF									
	Address to: Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450								
			37 CFR 1.97(b)						
1.	1. In Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.								
			37 CFR 1.97(c)						
2.	2. The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:								
☐ the statement specified in 37 CFR 1.97(e);									
OR									
	☐ the fe	ee set forth in 37 CFF	R 1.17(p).						

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT (Under 35 OFR 4.97(b) or 1.97(c))						Docket No. BUR920040182US1		
In Re Application Fen Chen et al.		Æ.						
Application No. Filing Date Examine				Customer No.	Group Art Unit	Confirmation No.		
10/711,418 09/17/2004				30449	2812			
Title: NON-DESTRUCT	IVE EVALUATION	OF MICROSTRUCTU	RE AND	INTERFACE I	ROUGHNESS O	F		
Payment of Fee (Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p)) A check in the amount of								
cc.								

INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

Docket Number (Optional)	Application Number		
BUR920040182US1	10/711,418		
Applicant(s) Fen Chen et al.			
Fen Chen et al.			
Filing Date	Group Art Unit		
00/17/2004	2012		

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				Filing Date 09/17/2004	•	Group Art Unit 2812			
			U.	S. PATENT DOCUMENTS					
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		EP 1 376 680 A1	02.01.2004	European Patent Office			A EG	1	
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			OTHER:	DOCUMENTS (Including Auth	or, Title, Date, Pe	ertinent Pages, Etc	c.)	Ā	
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EXAMINER				DATE CONSIDERED	DATE CONSIDERED				
		al if citation considered, whether		conformance with MPEP Section 609;	Draw line throu	gh citation if not	in conform	ance and	

Form PTO-A820 (also form PTO-1449)